

Advanced Dual PWM Power Controller

Features

- 2 Regulated Voltage are provided
 - SYNC Switching Power Internal Reference Voltage (1.25V , 1.5V , 1.8V and 2.05V)
 - ASYNC Switching Power Internal Reference Voltage (1.5V)
- Simple Single-Loop Control Design
 - Voltage-Mode PWM Control
- Excellent Output Voltage Regulation
 - SYNC Output : $\pm 1\%$ Over Temperature
 - ASYNC Output : $\pm 3\%$ Over Temperature
- Fast Transient Response
 - High-Bandwidth Error Amplifier
 - Full 0% to 100% Duty Ratio
- Power-Good Output Voltage Monitor
- Over-Voltage and Over-Current Fault Monitors
- Small Converter Size
 - Constant Frequency Operation(200kHz)
 - Programmable Oscillator from 50kHz to 800kHz
 - Reduce External Component Count
- 20Pin , SOIC Package

Applications

- High Power 5V to 2.5 or 3.3V DC-DC Regulator
- VGA Card Power Regulation

General Description

The APW7036 provides complete power control and protection for two DC-DC converter optimized in VGA Card applications. It integrates two PWM controllers , as well as the monitoring and protection function into a single package.

The APW7036 provides simple , single feedback loop , voltage mode control with fast transient response. The output voltage of the SYNC converter can be precisely regulated to as low as V_{REF} (1.25V , 1.5V , 1.8V and 2.05V) , with a maximum tolerance of $\pm 1.0\%$ over temperature.

The APW7036 can provides in excess of 14A of output current for an on-board DC/DC converter. It can monitors all the output voltage , and a single Power Good signal is issued when the SYNC output is within $\pm 10\%$ of the V_{REF} setting and the ASYNC output levels is above under-voltage levels. Additional built-in over-voltage protection for the SYNC output uses the lower MOSFET to prevent output voltage above 115% of the V_{REF} setting. The PWM controller's over-current function monitor the output current by sensing the voltage drop across the upper MOSFET's $R_{DS(ON)}$, eliminating the need for a current sensing resistor .

Pin Description

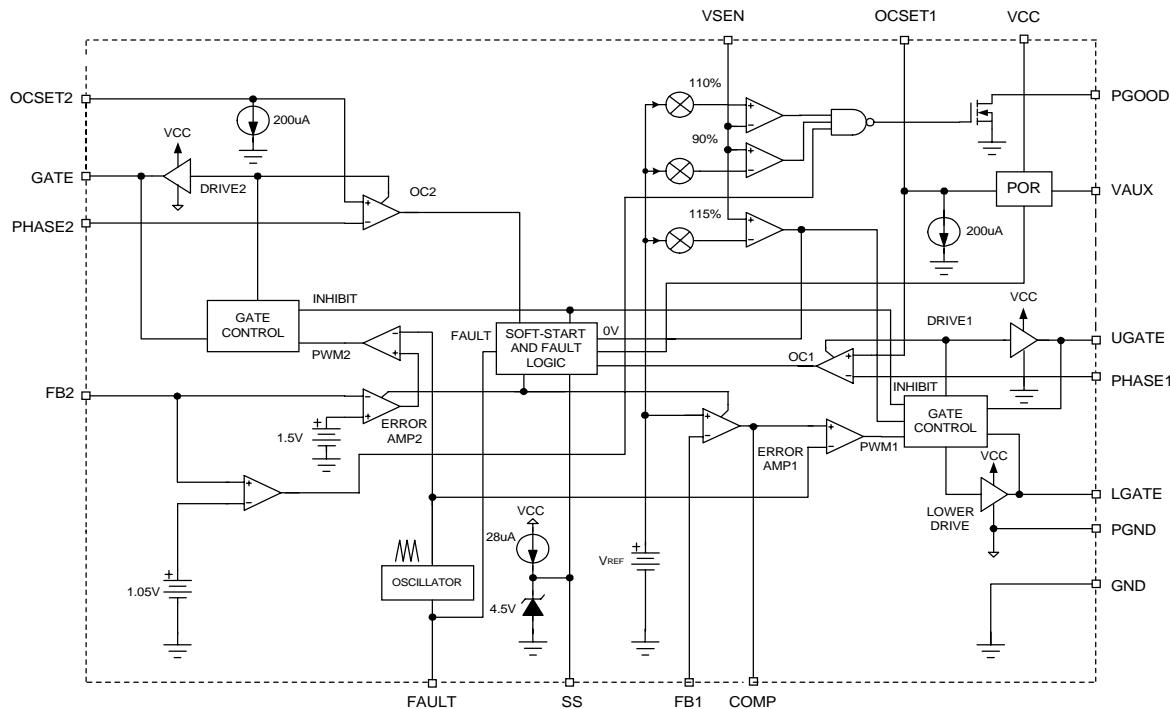
| | | | |
|----------|----|----|--------|
| UGATE | 1 | 20 | PHASE1 |
| VCC | 2 | 19 | LGATE |
| GATE | 3 | 18 | PGND |
| PHASE2 | 4 | 17 | OCSET1 |
| PGOOD | 5 | 16 | VSEN |
| OCSET2 | 6 | 15 | FB1 |
| FB2 | 7 | 14 | COMP |
| SS | 8 | 13 | NC |
| FAULT/RT | 9 | 12 | GND |
| NC | 10 | 11 | VAUX |

ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Ordering Information

| | | |
|---------|--|---|
| APW7036 | | VREF Voltage Code 12 : 1.25V 15 : 1.50V 18 : 1.80V 20 : 2.05V |
| | | Package Code K : SOP - 20 |
| | | Temp. Range C : 0 to 70 °C |
| | | Handling Code TU : Tube |
| | | TR : Tape & Reel |

Block Diagram



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|------------|-------------------------------------|------------------------|------|
| VCC | Supply Voltage | 15 | V |
| V_I, V_O | Input , Output or I/O Voltage | GND -0.3 V to V12 +0.3 | V |
| T_A | Operating Ambient Temperature Range | 0 to 70 | °C |
| T_J | Junction Temperature Range | 0 to 125 | °C |
| T_{STG} | Storage Temperature Range | -65 to +150 | °C |
| T_S | Soldering Temperature | 300 ,10 seconds | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|--|----------|------|
| $R_{\theta JA}$ | Thermal Resistance in Free Air SOIC SOIC (with 3in ² of Copper) | 75 65 | °C/W |
| | | | |

Electrical Characteristics

(Recommended operating conditions , Unless otherwise noted) Refer to Block and Simplified Power System Diagrams , and Typical Application Schematic

| Symbol | Parameter | Test Conditions | APW7036 | | | Unit |
|---|-------------------------------------|--|---------|------|------|------------------|
| | | | Min. | Typ. | Max. | |
| V_{CC} Supply Current | | | | | | |
| I _{CC} | Nominal Supply Current | UGATE , LGATE , GATE , open | | 9 | | mA |
| Power-on Reset | | | | | | |
| | Rising VCC Threshold | V _{OCSET} =4.5V | | | 10.4 | V |
| | Falling VCC Threshold | V _{OCSET} =4.5V | 8.2 | | | V |
| | Rising VAUX Threshold | V _{OCSET} =4.5V | | 2.5 | | V |
| | VAUX Threshold Hysteresis | V _{OCSET} =4.5V | | 0.5 | | V |
| | Rising V _{OCSET} Threshold | | | 1.26 | | V |
| Oscillator | | | | | | |
| F _{OCS} | Free Running Frequency | RT= Open | 185 | 200 | 215 | kHz |
| ΔV _{OSC} | Ramp Amplitude | RT= Open | | 1.9 | | V _{P-P} |
| Switching Controller Reference Voltage | | | | | | |
| V _{REF} | Reference Voltage APW7036-12 | | | 1.25 | | V |
| | APW7036-15 | | | 1.50 | | |
| | APW7036-18 | | | 1.80 | | |
| | APW7036-20 | | | 2.05 | | |
| | Reference Voltage accuracy | | -1.0 | | +1.0 | % |
| V _{FB2} | Reference Voltage | | | 1.5 | | V |
| | Reference Voltage accuracy | | -3.0 | | +3.0 | % |
| Synchronous PWM Controller Error Amplifier | | | | | | |
| | DC Gain | | | 88 | | dB |
| GBWP | Gain-Bandwidth Product | | | 15 | | MHz |
| SR | Slew Rate | COMP=10pF | | 6 | | V/μs |
| PWM Controllers Gate Drivers | | | | | | |
| I _{UGATE} | UGATE1,GATE Source | V _{CC} =12V, V _{UGATE1,GATE} =6V | | 1 | | A |
| R _{UGATE} | UGATE1,GATE Sink | V _{UGATE1,GATE} =1V | | | 3.5 | Ω |

Electrical Characteristics Cont.

| Symbol | Parameter | Test Conditions | APW7036 | | | Unit |
|-------------------------------------|--|----------------------------|---------|------|------|----------|
| | | | Min. | Typ. | Max. | |
| PWM Controllers Gate Drivers | | | | | | |
| I_{LGATE} | LGATE Source | $V_{CC}=12V, V_{LGATE}=1V$ | | 1 | | A |
| R_{LGATE} | LGATE Sink | $V_{LGATE}= 1V$ | | | 3 | Ω |
| Protection | | | | | | |
| | VSEN Over-Voltage (V_{SEN}/V_{REF}) | VSEN Rising | | 115 | 120 | % |
| I_{OVP} | FAULT Souring Current | $V_{FAULT/RT}=2.0V$ | | 8.5 | | mA |
| I_{OCSET} | OCSET1,2 Current Source | $V_{OCSET}= 4.5V_{DC}$ | 170 | 200 | 230 | μA |
| I_{SS} | Soft Start Current | | | 28 | | μA |
| Power Good | | | | | | |
| | VSEN Upper Threshold (V_{SEN}/V_{REF}) | VSEN1 Rising | | 110 | | % |
| | VSEN Under Voltage (V_{SEN}/V_{REF}) | VSEN1 Rising | | 94 | | % |
| | VSEN Hysteresis (V_{SEN}/V_{REF}) | Upper /Lower Threshold | | 2 | | % |
| V_{PGOOD} | PGOOD Voltage Low | $I_{PGOOD}= -4mA$ | | | 0.8 | V |

Functional Pin Description

UGATE (Pin 1)

Connect UGATE pin to the synchronous PWM converter's upper MOSFET gate. This pin provides the gate drive for the upper MOSFET.

VCC (Pin 2)

Provide a 12V bias supply for the IC to this pin. This pin also provides the gate bias charge for all the MOSFETs controlled by the IC. The voltage at this pin is monitored for Power-On Reset purposes.

GATE (Pin 3)

Connect GATE pin to the standard BUCK PWM converter's MOSFET gate. This pin provides the gate drive for the MOSFET.

PHASE2 (Pin 4)

Connect the PHASE2 pin to the standard BUCK PWM

converter's MOSFET source. This pin is used to monitor the voltage drop across the MOSFET for over-current protection.

PGOOD (Pin 5)

PGOOD is an open collector output used to indicate the status of the output voltages. This pin is pulled low when the synchronous regulator output is not within 10% of the reference voltage or the other output is below under-voltage thresholds.

NC (Pin 10, 13)

No Connection.

OCSET1 , 2 (Pin 17 , 6)

Connect a resistor (R_{OCSET}) from this pin to the drain of the PWM converter's MOSFET. R_{OCSET} , an internal 200 μA current source (I_{OCSET}), and the MOSFET's on-resistance($r_{DS(ON)}$) set the converter over-current

Functional Pin Description Cont.

(OC) trip point according to the following equation:

$$I_{PEAK} = \frac{I_{OCSET} * R_{OCSET}}{r_{DS(ON)}}$$

An over-current trip cycles the soft-start function.

FB2 (Pin 7)

This pin provides the feedback for the non-synchronous switching regulator. A resistor driver is connected from this pin to regulator output and GND that sets the output voltage. The value of the resistor connected from regulator output to FB2 must be less than 150Ω .

SS (Pin 8)

Connect a capacitor from this pin to ground. This capacitor , along with an internal $28\mu A$ current source , sets the soft-start interval of the converter.

FAULT / RT (Pin 9)

This pin provides oscillator switching frequency adjustment. By placing a resistor (R_T) from this pin to GND , the nominal 200kHz switching frequency is increased. Conversely , connecting a pull-up resistor (R_T) from this pin to VCC reduces the switching frequency.

Nominally , the voltage at this pin is 1.26V. In the event of an over-voltage or over-current condition , this pin is internally pulled to VCC.

VAUX (Pin 11)

The +3.3V input voltage at this pin is monitored for power-on reset (POR) purposes.

GND (Pin 12)

Signal ground for the IC. All voltage levels are measured with respect to this pin.

COMP and FB1 (Pins 14 , and 15)

COMP and FB1 are the available external pins of the

synchronous PWM regulator error amplifier. The FB1 pin is the inverting input of the error amplifier. Similarly , the COMP pin is the error amplifier output. These pins are used to compensate the voltage-mode control feedback loop of the synchronous PWM converter.

VSEN (Pin 16)

This pin is connected to the synchronous PWM converters's output voltage. The PGOOD and OVP comparator circuits use this signal to report output voltage status and for over-voltage protection.

PGND (Pin 18)

This is the power ground connection. Tie the synchronous PWM converter's lower MOSFET source to this pin.

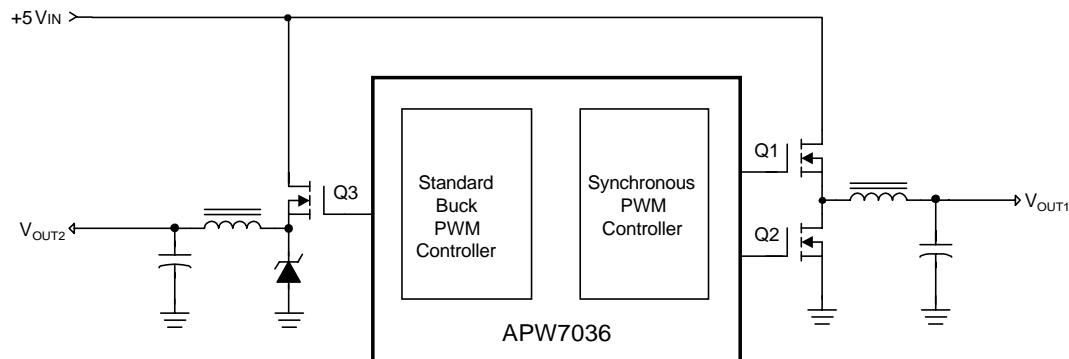
LGATE (Pin19)

Connect LGATE to the synchronous PWM converter's lower MOSFET gate. This pin provides the gate drive for the lower MOSFET.

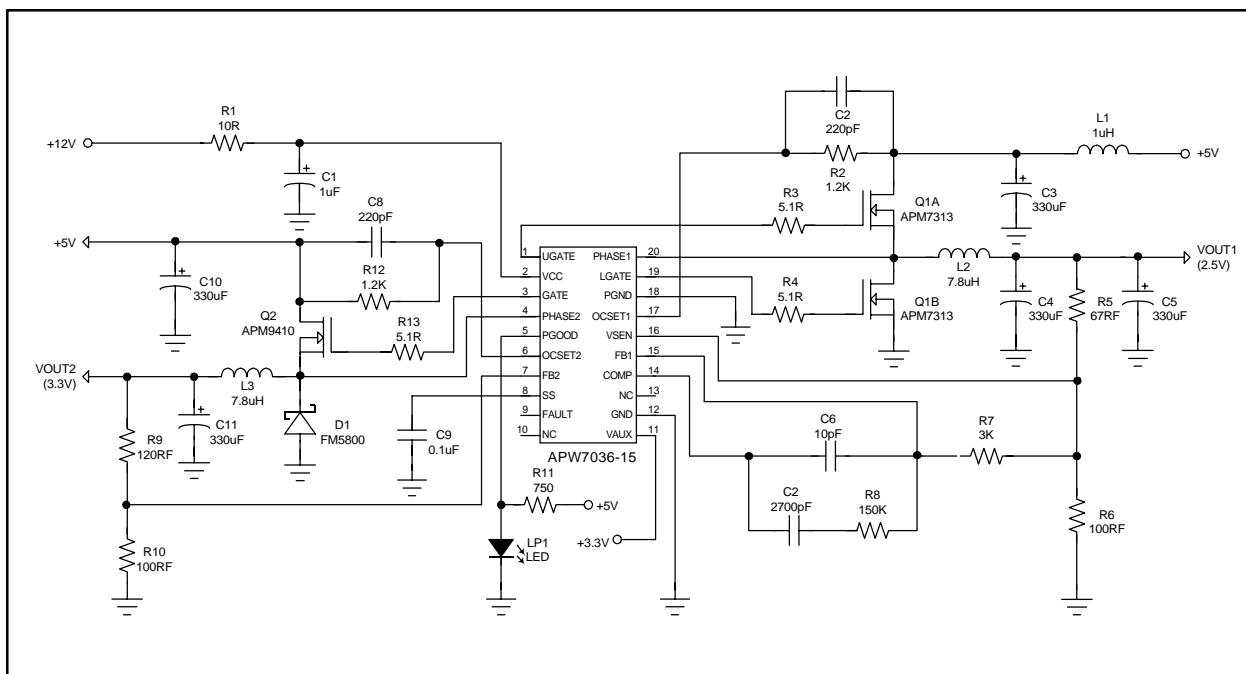
PHASE1 (Pin 20)

Connect the PHASE1 pin to the synchronous PWM converter's upper MOSFET source. This pin is used to monitor the voltage drop across the upper MOSFET for over-current protection.

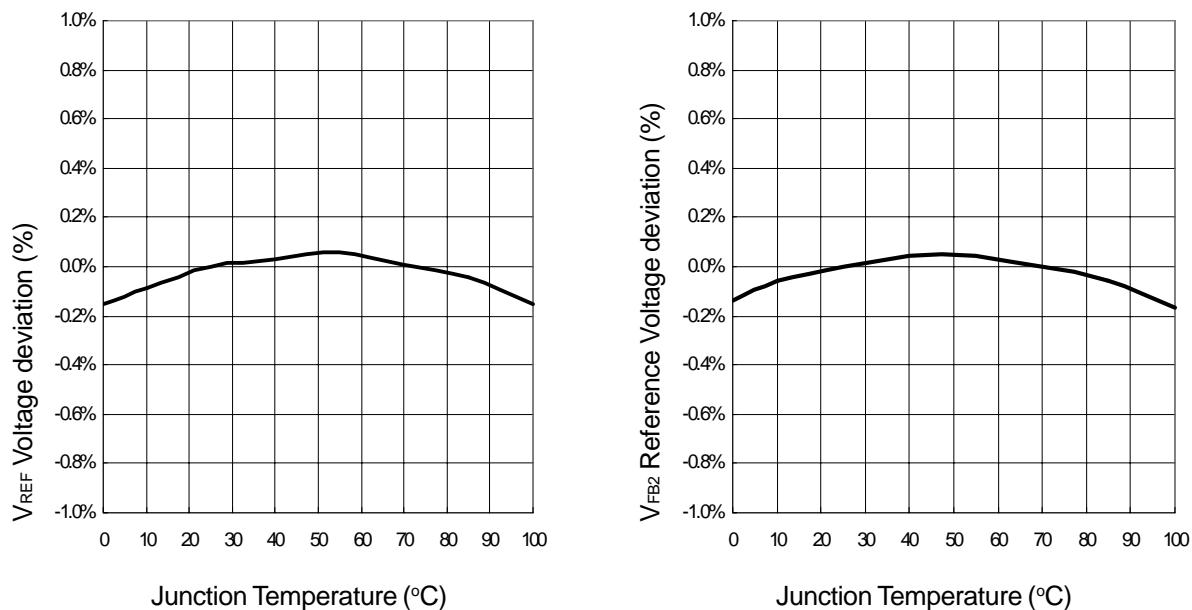
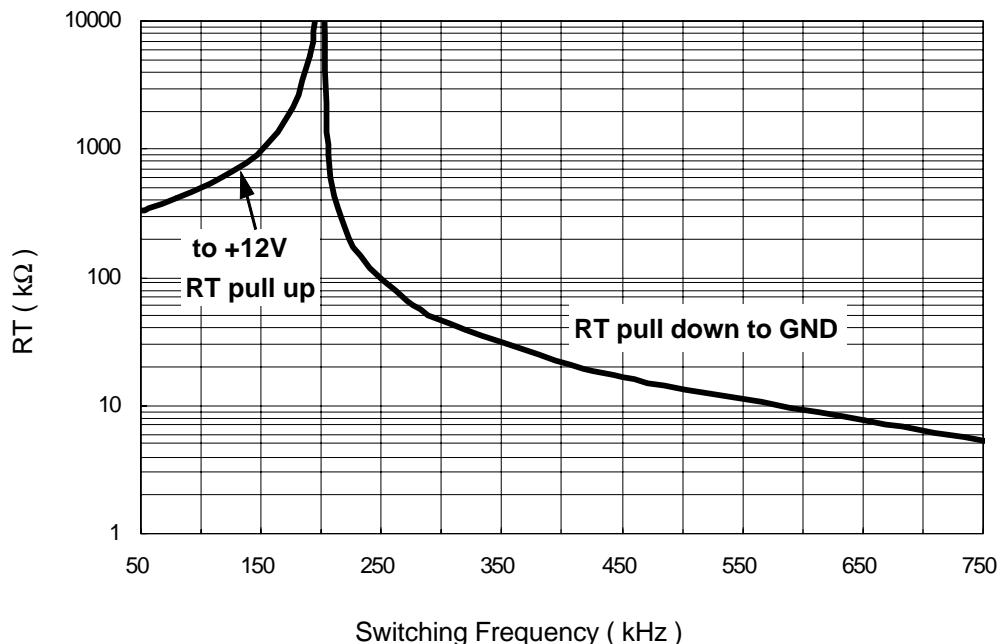
Simplified Power System Diagram



Typical Characteristics



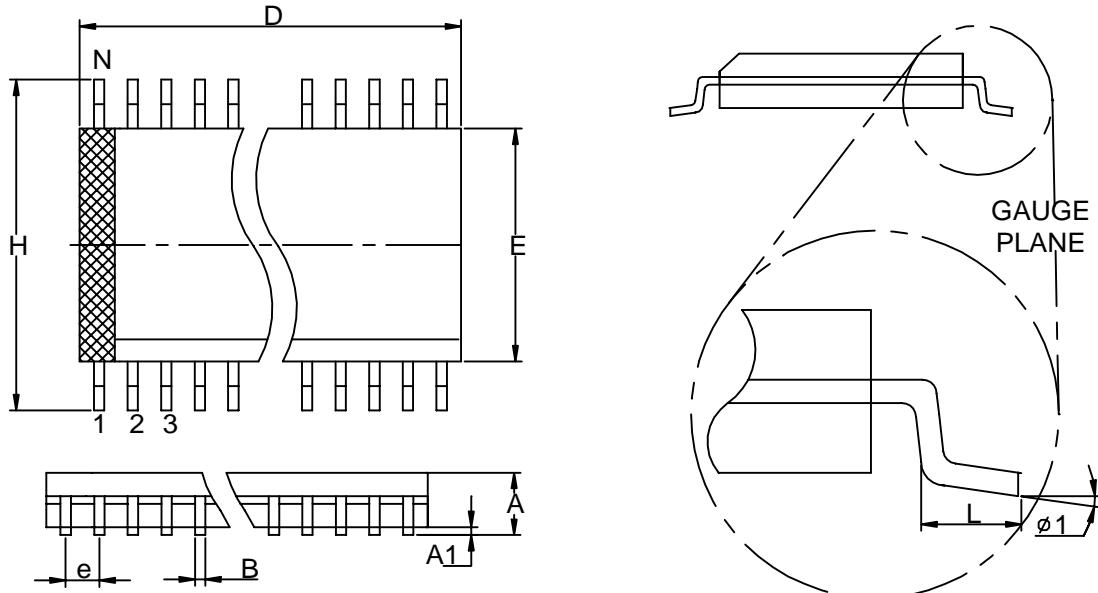
Typical Characteristics



Note : The Reference Voltage(V_{REF}) Deviation is $\frac{V_{REF}(T_J) - V_{REF}(25^{\circ}\text{C})}{V_{REF}(25^{\circ}\text{C})} \times 100\%$

Package Information

SO – 300mil (Reference JEDEC Registration MS-013)



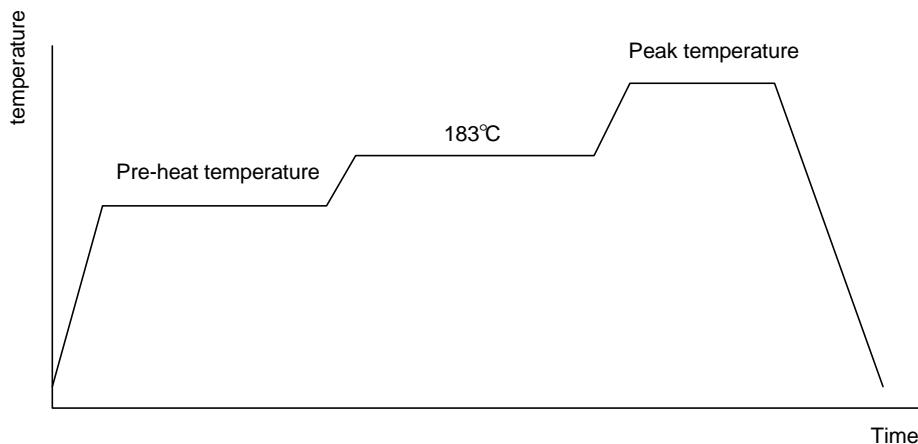
| Dim | Millimeters | | Variations- D | | | Dim | Inches | | Variations- D | | |
|----------|----------------|-------|---------------|-------|-------|----------|----------------|--------|---------------|-------|-------|
| | Min. | Max. | Variations | Min. | Max. | | Min. | Max. | Variations | Min. | Max. |
| A | 2.35 | 2.65 | SO-16 | 10.10 | 10.50 | A | 0.093 | 0.1043 | SO-16 | 0.398 | 0.413 |
| A1 | 0.10 | 0.30 | SO-18 | 11.35 | 11.76 | A1 | 0.004 | 0.0120 | SO-18 | 0.447 | 0.463 |
| B | 0.33 | 0.51 | SO-20 | 12.60 | 13 | B | 0.013 | 0.020 | SO-20 | 0.496 | 0.512 |
| D | See variations | | SO-24 | 15.20 | 15.60 | D | See variations | | SO-24 | 0.599 | 0.614 |
| E | 7.40 | 7.60 | SO-28 | 17.70 | 18.11 | E | 0.2914 | 0.2992 | SO-28 | 0.697 | 0.713 |
| e | 1.27BSC | | SO-14 | 8.80 | 9.20 | e | 0.050BSC | | SO-14 | 0.347 | 0.362 |
| H | 10 | 10.65 | | | | H | 0.394 | 0.419 | | | |
| L | 0.40 | 1.27 | | | | L | 0.016 | 0.050 | | | |
| N | See variations | | | | | N | See variations | | | | |
| ϕ 1 | 0° | 8° | | | | ϕ 1 | 0° | 8° | | | |

Physical Specifications

| | |
|--------------------|--|
| Terminal Material | Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb) |
| Lead Solderability | Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3. |
| Packaging | 1000 devices per reel |

Reflow Condition (IR/ Convection or VPR Reflow)

Reference JEDEC Standard J-STD-020A APRIL 1999



Classification Reflow Profiles

| | Convection or IR/ Convection | VPR |
|--|------------------------------|---------------------------|
| Average ramp-up rate(183°C to Peak) | 3°C/second max. | 10 °C /second max. |
| Preheat temperature 125 ± 25°C) | 120 seconds max. | |
| Temperature maintained above 183°C | 60 ~ 150 seconds | |
| Time within 5°C of actual peak temperature | 10 ~ 20 seconds | 60 seconds |
| Peak temperature range | 220 +5/-0°C or 235 +5/-0°C | 215~ 219°C or 235 +5/-0°C |
| Ramp-down rate | 6 °C /second max. | 10 °C /second max. |
| Time 25°C to peak temperature | 6 minutes max. | |

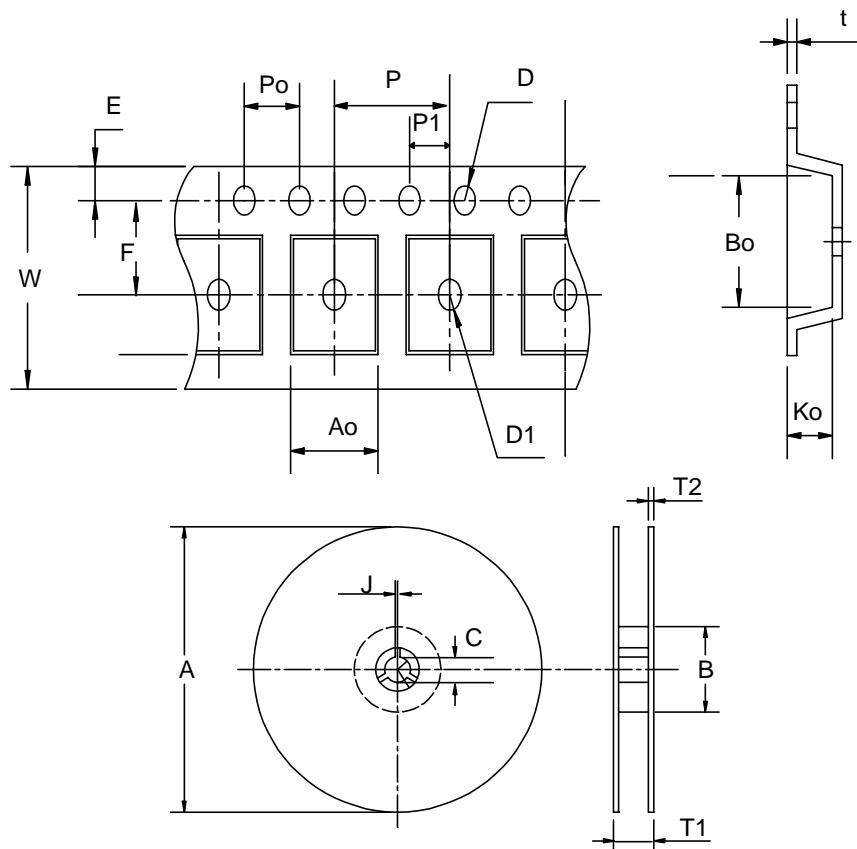
Package Reflow Conditions

| pkg. thickness ≥ 2.5mm and all bags | pkg. thickness < 2.5mm and pkg. volume ≥ 350 mm ³ | pkg. thickness < 2.5mm and pkg. volume < 350mm ³ |
|--|---|--|
| Convection 220 +5/-0 °C | Convection 235 +5/-0 °C | |
| VPR 215-219 °C | VPR 235 +5/-0 °C | |
| IR/Convection 220 +5/-0 °C | IR/Convection 235 +5/-0 °C | |

Reliability test program

| Test item | Method | Description |
|---------------|---------------------|---------------------------|
| SOLDERABILITY | MIL-STD-883D-2003 | 245°C , 5 SEC |
| HOLT | MIL-STD-883D-1005.7 | 1000 Hrs Bias @ 125 °C |
| PCT | JESD-22-B, A102 | 168 Hrs, 100 % RH , 121°C |
| TST | MIL-STD-883D-1011.9 | -65°C ~ 150°C, 200 Cycles |
| ESD | MIL-STD-883D-3015.7 | VHBM > 2KV, VMM > 200V |
| Latch-Up | JESD 78 | 10ms , $I_{tr} > 100mA$ |

Tape & Reel Dimensions



| Application | A | B | C | J | T1 | T2 | W | P | E |
|---------------|----------------|--------------|------------------|---------------|---------------|---------------|------------------|---------------|------------------|
| SOP-20 | 330 ± 1 | 62 ± 1.5 | 12.75 ± 0.15 | $2 + 0.6$ | $24.4 +0.2$ | 2 ± 0.2 | $24 + 0.3 - 0.1$ | 12 ± 0.1 | 1.75 ± 0.1 |
| Application | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| SOP-20 | 11.5 ± 0.1 | $1.5+0.1$ | $1.5+0.25$ | 4.0 ± 0.1 | 2.0 ± 0.1 | 8.2 ± 0.1 | 13 ± 0.1 | 2.5 ± 0.1 | 0.35 ± 0.013 |

(mm)

Cover Tape Dimensions

| | |
|-------------------------|------|
| Carrier Width | 24 |
| Cover Tape Width | 21.3 |

Customer Service

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